

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to +150°C
V _{DD} Voltage	–0.5V to +3.6V
Input/Output Voltage ⁽⁴⁾	–0.5V to V _{DD} +0.5V
DC Output Current	–60mA to +60mA
Power Dissipation	500mW

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Operating Range

V _{IN} Voltage	–0.3V to 3.6V
V _{DD} Voltage	2.5V ± 0.2V
Industrial Temperature	–40°C to +85°C
Input Frequency	DC to 150 MHz
Capacitive Loading	10pF to 25pF

DC Electrical Characteristics (Over the Operating Range)

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Units
V _{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level (Input Pins)		1.7	—		V
V _{IL}	Input LOW Voltage	Guaranteed Logic LOW Level (Input Pins)			—	0.7	
I _I	Input Current	V _{DD} = Max., V _{IN} = V _{DD} or GND	V _{IN} = V _{DD}	—	—	±1	mA
V _{IK}	Clamp Diode Voltage	V _{DD} = Min., I _{IN} = –18mA		—	–0.7	–1	V
V _{OH}	Output HIGH Voltage	V _{DD} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OH} = –1mA	2	—	—	
			I _{OH} = –8mA	1.8 ⁽³⁾	—	—	
V _{OL}	Output LOW Voltage	V _{DD} = Min., V _{IN} = V _{IH} or V _{IL}	I _{OL} = 1mA	—	—	0.4	
			I _{OL} = 8mA	—	—	0.6	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{DD} = 2.5V, +25°C ambient and maximum loading.
- V_{OH} = V_{DD} – 0.6V at rated current.
- This value is limited to 3.6V maximum.

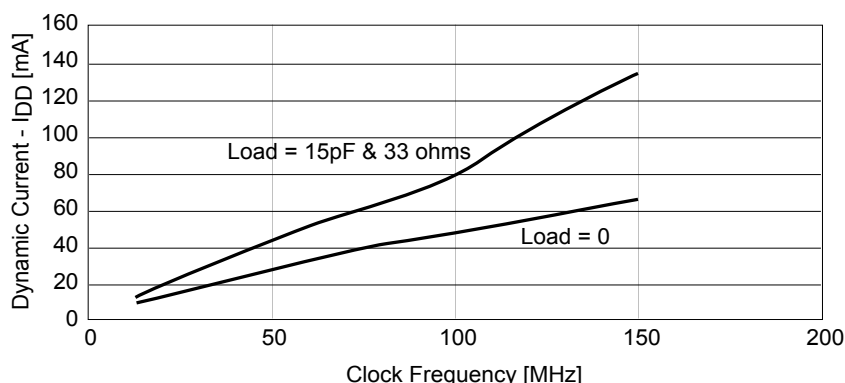
Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Units
I _{DDQ}	Quiescent Power Supply Current	V _{DD} = Max.	V _{IN} = GND or V _{DD}	—	0.1	20	μA
ΔI _{DD}	Supply Current per Inputs @ TTL HIGH	V _{DD} = Max.	V _{IN} = V _{DD} – 0.6V ⁽³⁾	—	47	300	
I _{DD}	Dynamic Supply Current (See Graph 1)	V _{DD} = 2.7V, 15pF & 33-ohm load	150 MHz	—	136	—	mA

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at V_{DD} = 2.5V, +25°C ambient.
- Per TTL driven input (V_{IN} = V_{DD} – 0.6V); all other inputs at V_{DD} or GND.

Graph 1. Dynamic Current vs. Clock Frequency



Capacitance ($T_A = 25^\circ\text{C}$, $f = 1\text{ MHz}$)

Parameters ⁽¹⁾	Description	Test Conditions	Typ.	Max.	Units
C_{IN}	Input Capacitance	$V_{IN} = 0\text{V}$	3	4	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0\text{V}$		6	

Note:

1. This parameter is determined by device characterization but is not production tested.

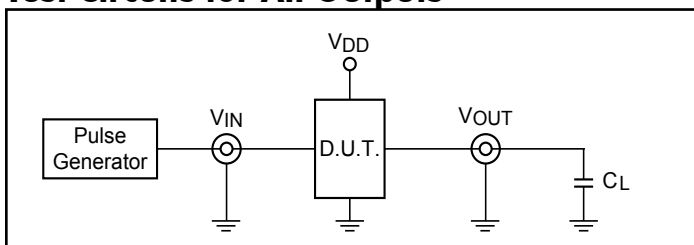
Switching Characteristics ($V_{DD} = 2.5\text{V} \pm 0.2\text{V}$, $T_A = 85^\circ\text{C}$)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ.	Max.	Units
t_R/t_F	CLKn Rise/Fall Time 0.7V ~ 1.7 V	$C_L = 22\text{pF}$, 100 MHz	–	1.0	1.25	ns
		$C_L = 12\text{pF}$, 150 MHz	–	1.0	1.2	
t_{PLH} t_{PHL}	Propagation Delay BUF_IN to CLKn	$C_L = 22\text{pF}$, 100 MHz	–	3.0	3.5	
		$C_L = 12\text{pF}$, 150 MHz	–	2.4	2.7	
$t_{SK(o)}^{(2)}$	Skew between two outputs of the same package (same transition)	$C_L = 22\text{pF}$, 100 MHz	–	100	150	ps
		$C_L = 12\text{pF}$, 150 MHz	–	100	150	
$t_{SK(p)}^{(2)}$	Skew between opposite transitions ($t_{PHL}-t_{PLH}$) of the same output	$C_L = 22\text{pF}$, 100 MHz	–	250	300	
		$C_L = 12\text{pF}$, 150 MHz	–	250	300	
$t_{SK(t)}^{(2)}$	Skew between two outputs of different package ⁽⁴⁾	$C_L = 12\text{pF}$, 150 MHz	–	400	600	

Notes:

1. See test circuit and waveforms.
2. Skew measured at worse cast temperature (max. temp).

Test Circuits for All Outputs

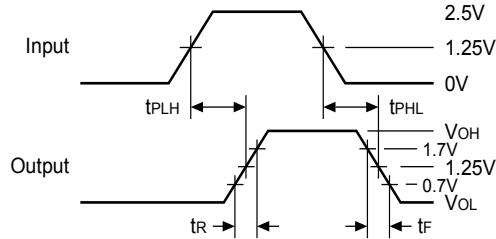


Definitions:

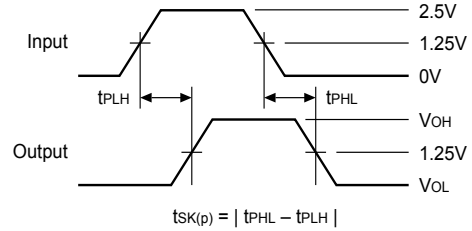
C_L = Load capacitance: includes jig and probe capacitance.

Switching Waveforms

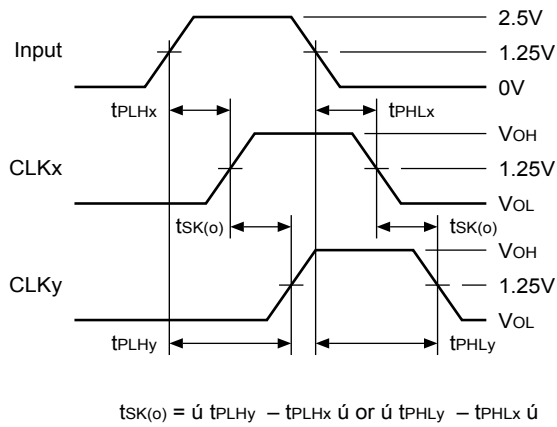
Propagation Delay



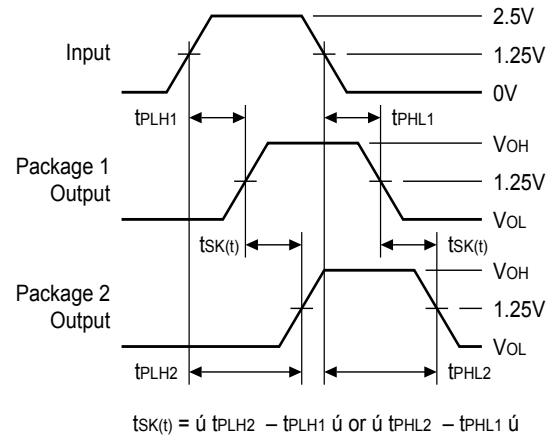
Pulse Skew – $t_{SK(P)}$



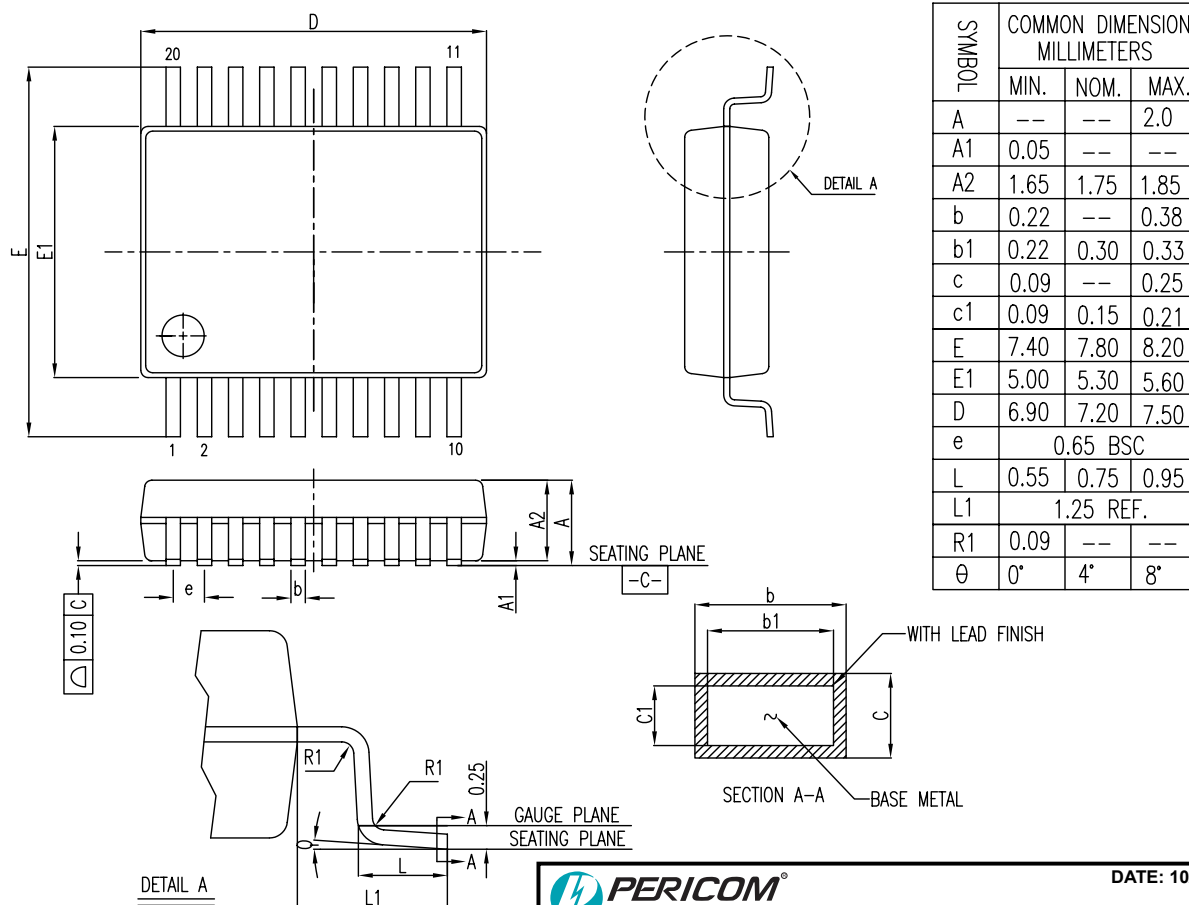
Output Skew – $t_{SK(O)}$



Package Skew – $t_{SK(T)}$



Packaging Mechanical: 20-Pin SSOP (H)



NOTE:

1. Controlling dimensions in millimeters
2. Ref.: JEDEC MO-150B/AE
3. Package Outline Exclusive of Mold Flash and Metal Burr



DATE: 10/31/13

DESCRIPTION: 20-Pin, 209-Mil Wide, SSOP

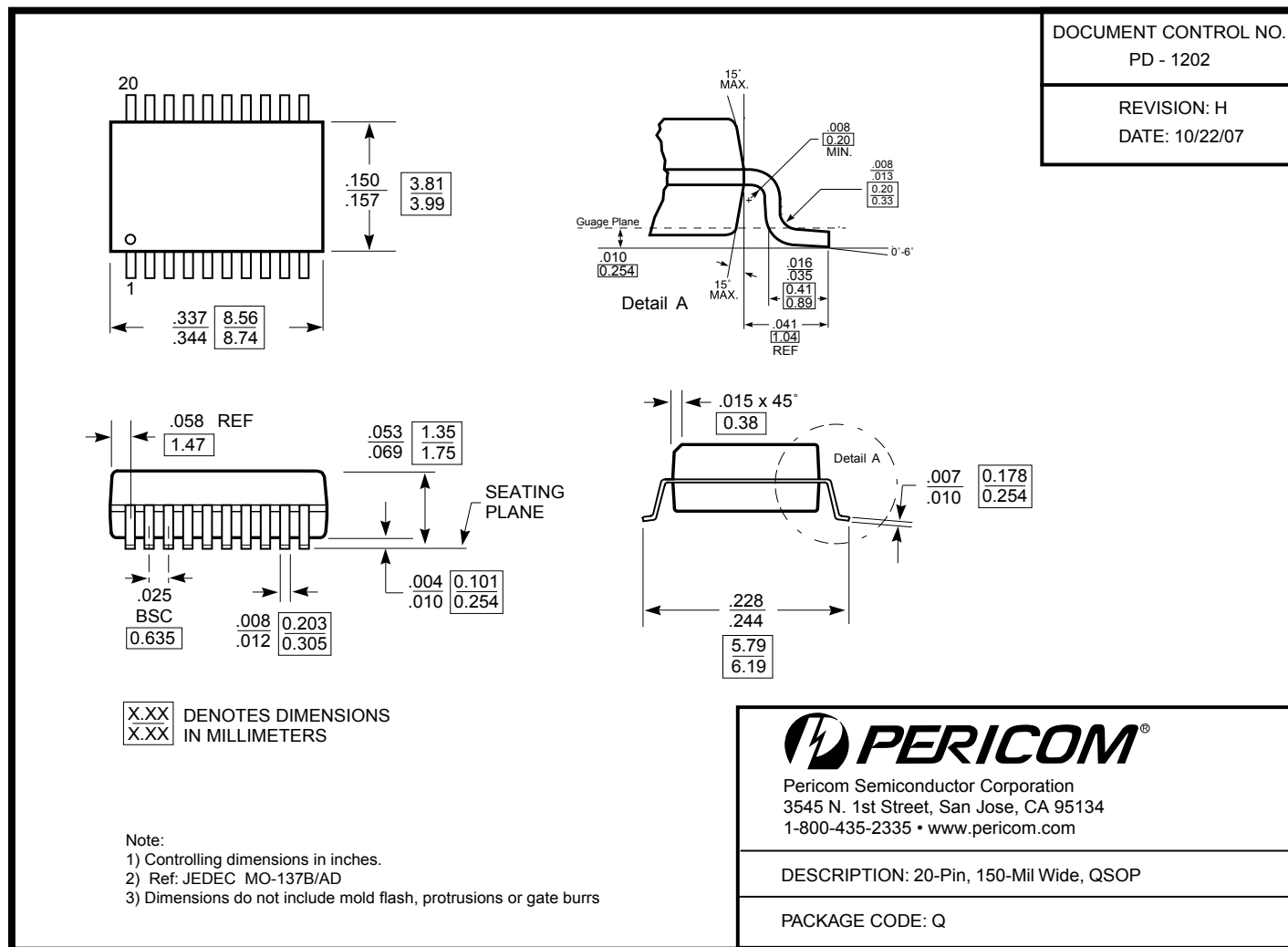
PACKAGE CODE: H20

DOCUMENT CONTROL #: PD-1240

REVISION: F

13-0214

Packaging Mechanical: 20-Pin QSOP (Q)



Note: For latest package info, please check: <http://www.pericom.com/support/packaging/packaging-mechanicals-and-thermal-characteristics/>

Ordering Information

Ordering Number	Package Code	Package Description
PI49FCT20807QE	Q	20-Pin, 150-Mil Wide (QSOP)
PI49FCT20807HE	H	20-Pin, 209-Mil Wide (SSOP)

Notes:

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel